VAF 05



- Series name
 Output wattage
 Output voltage

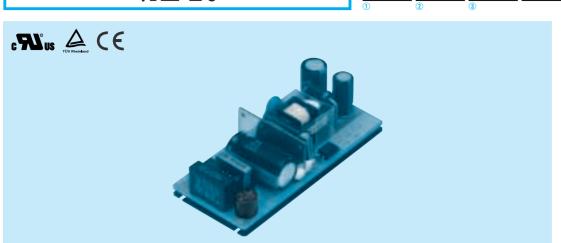
MODEL		VAF503	VAF505	VAF512	VAF524
MAX OUTPUT WATTAGE[W]		3.3	5.0	5.4	5.28
DC OUTDUT	VOLTAGE[V]	3.3	5	12	24
DC OUTPUT	CURRENT[A]	1.0 (Peak 1.2)	1.0 (Peak 1.2)	0.45 (Peak 0.54)	0.22 (Peak 0.27)

SPECIFICATIONS

M	IODEL		VAF503	VAF505	VAF512	VAF524		
V	VOLTAGE[V]		AC85 - 264 1 p or DC110 - 370					
	URRENT[A]	ACIN 100V	0.15typ (lo=100%)					
C	UKKENI[A]	ACIN 200V	0.10typ (lo=100%)					
INPUT FI	FREQUENCY[Hz]		47 - 440 or DC					
-			15typ (Io=100%)					
liv.			30typ (lo=100%)					
LI	LEAKAGE CURRENT[mA]		0.5max (60Hz, According to IEC60950 and DEN-AN)					
E	FFICIENCY[%]		68typ	77typ	78typ	81typ		
V	OLTAGE[V]		3.3	5	12	24		
	URRENT[A]		1.0 (Peak 1.2)	1.0 (Peak 1.2)	0.45 (Peak 0.54)	0.22 (Peak 0.27)		
	INE REGULATION[-	20max	20max	48max	96max		
LC	OAD REGULATION		40max	40max	100max	150max		
			80max	80max	120max	150max		
R	IPPLE[mVp-p]		140max	140max	160max	200max		
			180max	180max	200max	240max		
OUTPUT			120max	120max	150max	200max		
RI	IPPLE NOISE[mVp-p]	-10 - 0℃ *2	160max	160max	180max	230max		
			200max	200max	220max	260max		
TEI	MPERATURE COEFFICIENT[mV]	-10 to +55℃	100max	50max	120max	300max		
	DRIFT[mV] *3		20max	20max	48max	96max		
01	OUTPUT VOLTAGE SETTING[V]		3.19 - 3.47	4.90 - 5.30	11.40 - 12.60	23.0 - 25.0		
OU	OUTPUT VOLTAGE ADJUSTMENT RANGE[V]							
S ⁻	START-UP TIME[ms]		700max (ACIN 85V, Io=100%)					
	HOLD-UP TIME[ms]		10typ (ACIN 85V, Io=100%), 20typ (ACIN 100V, Io=100%)					
	OVERCURRENT PROTECTION		Works over 125% of rating and recovers automatically					
			Works over 115% of rating (By zener diode clamping)					
IN	INPUT-OUTPUT		AC3,000V 1minute, Cutoff current = 10mA, DC500V 50M Ω min (At Room Temperature)					
ISOLATION IN	NPUT-FG		AC2,000V 1minute, Cutoff current = 10mA, DC500V 50M Ω min (At Room Temperature)					
	UTPUT-FG		AC500V 1minute, Cutoff current = 100mA, DC500V 50M Ω min (At Room Temperature)					
			-10 to +71°C, 20 - 90%RH (Non condensing) (Refer to DERATING CURVE), 3,000m (10,000feet) max					
ENVIRONMENT —		ALTITUDE	-20 to +75℃, 20 - 90%RH (Non condensing), 9,000m (30,000feet) max					
VI	IBRATION		19.6m/s² 10 - 55Hz, 3minutes period, 60minutes each along X, Y and Z axis (Non operating)					
	IMPACT		196.1m/s ² 11ms, once each X, Y and Z axis (Non operating)					
NOISE -	GENCY APPROVA	_	UL1950, C-UL, EN60950, VDE0160 Complies with DEN-AN and IEC60950					
REGULATIONS C	CONDUCTED NOISE		Complies with FCC-B, VCCI-B, CISPR22-B, EN55022-B					
OTHERS -	CASE SIZE/WEIGHT		32×20×72.5mm (W×H×D) / 30g max					
C	COOLING METHOD		Convection					

- *1 Peak load for 10sec. or less in acceptable if the total wattage is less than the rated wattage.
 *2 This is the value that measured on measuring board with capasitor of 22 µ F. Measuared by 20MHz oscilloscope or Ripple-Noise meter (Equivalent to KEISOKU-GIKEN: RM101).
 *3 Drift is the change in DC output for an eight hour period after a half-hour warm-up at 25°C, with the input voltage held constant at the rated input/output.

10 05



- Series name
 Output wattage
 Output voltage

MODEL		VAF1003	VAF1005	VAF1012	VAF1024
MAX OUTPUT WATTAGE[W]		6.6	10.0	10.8	10.8
DC OUTDUT	VOLTAGE[V]	3.3	5	12	24
DC OUTPUT	CURRENT[A]	2.0 (Peak 2.4)	2.0 (Peak 2.4)	0.9 (Peak 1.08)	0.45 (Peak 0.54)

SPECIFICATIONS

	MODEL		VAF1003	VAF1005	VAF1012	VAF1024		
	VOLTAGE[V]		AC85 - 264 1φ or DC110 - 370					
INPUT	ACIN 100V		0.3typ (lo=100%)					
	CURRENT[A]	ACIN 200V	0.2typ (lo=100%)					
	FREQUENCY[Hz]		47 - 440 or DC					
			15typ (Io=100%)					
			30typ (lo=100%)					
	LEAKAGE CURRENT[mA]		0.5max (60Hz, According to IEC60950 and DEN-AN)					
	EFFICIENCY[%]		65typ	74typ	78typ	81typ		
	VOLTAGE[V]		3.3	5	12	24		
	CURRENT[A]	*1	2.0 (Peak 2.4)	2.0 (Peak 2.4)	0.9 (Peak 1.08)	0.45 (Peak 0.54)		
	LINE REGULATION[mV]	20max	20max	48max	96max		
	LOAD REGULATION	l[mV]	40max	40max	100max	150max		
		0 to +55℃ *2	80max	80max	120max	150max		
	RIPPLE[mVp-p]	-10 - 0℃ *2	140max	140max	160max	200max		
		lo=100 · 120% *2	180max	180max	200max	240max		
OUTPUT	RIPPLE NOISE[mVp-p]	0 to +55℃ *2	120max	120max	150max	200max		
OUIPUI		-10 - 0℃ *2	160max	160max	180max	230max		
		lo=100 · 120% *2	200max	200max	220max	260max		
_	TEMPERATURE COEFFICIENT[mV]	-10 to +55℃	100max	50max	120max	300max		
[DRIFT[mV] *3		20max	20max	48max	96max		
	OUTPUT VOLTAGE SETTING[V]		3.19 - 3.47	4.90 - 5.30	11.40 - 12.60	23.0 - 25.0		
	OUTPUT VOLTAGE ADJUSTMENT RANGE[V]							
	START-UP TIME[ms]		700max (ACIN 85V, Io=100%)					
	HOLD-UP TIME[ms]		10typ (ACIN 85V, Io=100%), 20typ (ACIN 100V, Io=100%)					
	OVERCURRENT PROTECTION		Works over 125% of rating and recovers automatically					
CIRCUIT			Works over 115% of rating (By zener diode clamping)					
	INPUT-OUTPUT		AC3,000V 1minute, Cutoff current = 10mA, DC500V 50M Ω min (At Room Temperature)					
ISOLATION	INPUT-FG		AC2,000V 1minute, Cutoff current = 10mA, DC500V 50M Ω min (At Room Temperature)					
	OUTPUT-FG		AC500V 1minute, Cutoff current = 100mA, DC500V 50M Ω min (At Room Temperature)					
	OPERATING TEMP.,HUMID.AND ALTITUDE		-10 to +71℃, 20 - 90%RH (Non condensing) (Refer to DERATING CURVE), 3,000m (10,000feet) max					
ENVIRONMENT	STORAGE TEMP.,HUMID.AND	ALTITUDE						
LIVINONIILIVI	VIBRATION		19.6m/s² 10 - 55Hz, 3minutes period, 60minutes each along X, Y and Z axis (Non operating)					
	IMPACT		196.1m/s ² 11ms, once each X, Y and Z axis (Non operating)					
NOISE	AGENCY APPROVA		UL1950, C-UL, EN60950, VDE0160 Complies with DEN-AN and IEC60950					
REGULATIONS	CONDUCTED NOISE		Complies with FCC-B, VCCI-B, CISPR22-B, EN55022-B					
OTHERS	CASE SIZE/WEIGHT		36×21×78mm (W×H×D) / 40g max					
OTTIERS	COOLING METHOD		Convection					

- *1 Peak load for 10sec. or less in acceptable if the total wattage is less than the rated wattage.
 *2 This is the value that measured on measuring board with capasitor of 22 µ F. Measuared by 20MHz oscilloscope or Ripple-Noise meter (Equivalent to KEISOKU-GIKEN: RM101).
 *3 Drift is the change in DC output for an eight hour period after a half-hour warm-up at 25°C, with the input voltage held constant at the rated input/output.

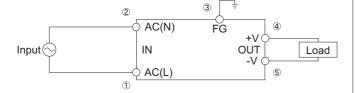


1	Pin Connection	F-140	
2	Function	F-140	
	2.1 Inrush current limiting 2.2 Peak current 2.3 Overcurrent protection 2.4 Overvoltage protection 2.5 Thermal protection 2.6 Isolation	F-140 F-140 F-140 F-140 F-140	
3	Wiring to Input/Output Pin	F-140	
4	Series Operation and Parallel Operation	F-141	
	4.1 Series operation ————————————————————————————————————		
5	Input Condition	F-141	
6	Assembling and Installation Method	F-141	
	6.1 Installation method ————————————————————————————————————		
7	Cleaning	F-142	
8	Soldering	F-142	VA
9	Input/Output Pin	F-142	
10	Ground	F-142	
11	Others	F-143	



Pin Connection

No.	Pin conne	ection	Function
1	AC(L)		Input pin AC85 - 264V 1¢
2	AC(N)		47 - 440Hz or DC110 - 370V
3	FG		Frame ground
4	OUT	+V	+Output
(5)	OUT	-V	-Output



2 Function

2.1 Inrush current limiting

- ■Inrush current limiting is built-in.
- ■If a switch on the input side is installed, it has to be the one handling the input inrush current.

2.2 Peak current

■Fig.2.1 shows the available range of peak output current.

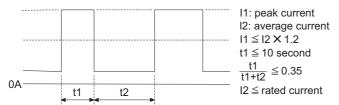


Fig.2.1 Peak current

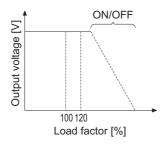


Fig.2.2 Overcurrent characteristics

2.3 Overcurrent protection

■Overcurrent protection circuit is built-in to be operated over 125% of the rated current. Overcurrent protection prevents the unit from short circuit and over current condition.

The unit automatically recovers when the fault condition is cleared.

2.4 Overvoltage protection

■Overvoltage protection circuit, clamping the output voltage by zener diode, is built-in comes into effect at over 115% of the rated voltage. (For 3V type, overvoltage protection kicks in at over 4V.) The unit in an overvoltage protection mode cannot be recovered by a user, it must be repaired at the factory.

Overvoltage protection (diode) also comes into effect if the voltage is externally applied to the output side. Avoid applying voltage to the output side.

2.5 Thermal protection

■Thermal protection is built-in. If this function comes into effect, shut down the output, eliminate all possible cause of overheating, and drop the temperature to normal level. Output voltage recovers after applying input voltage. To prevent the unit from overheating, avoid using the unit in a dusty, poorly ventilated environment.

2.6 Isolation

■For a receiving inspection, such as Hi-Pot test, gradually increase (decrease) the voltage for the start (shut down). Avoid using Hi-Pot tester with the timer because it may generate voltage a few times higher than the applied voltage, at ON/OFF of a timer.

3 Wiring to Input/ **Output Pin**

■To decrease output ripple voltage more, install external capacitor Co at output terminal as below.

Table 3.1 Capacity of external capacitor at output terminal: Co[µF]

Output voltage Co	3.3V/5V	12V	24V
Recommended value	220	100	47
Maximum value	2,200	1,000	470

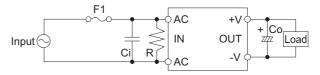


Fig.3.1 Connecting method of external capacitor at output terminal

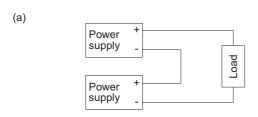
VAF

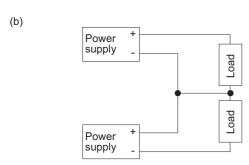


4 Series Operation and **Parallel Operation**

4.1 Series operation

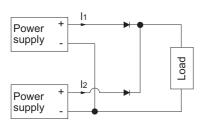
■Series operation is available by connecting the output of two or more power supplies, as shown below. Output current in series connection should be lower than the lowest rated in each unit.





4.2 Parallel redundancy operation

■Parallel redundancy operation is available by connecting the unit as shown below.



I1. I2 ≤ the rated current value

Input condition

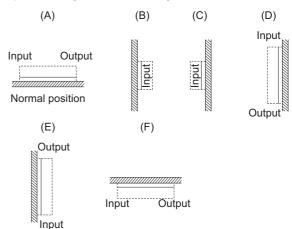
Following should be prohibited to avoid failure or malfunction.

- ■To continuously apply other than rated input voltage.
- ■To install the phase advance capacitor. (High voltage is generated when the input voltage is ON/OFF.)
- ■To apply input voltage less than AC60V. It makes output voltage turn on/off one after another in short period of time. This malfunction is also caused by installing a switch/SSR with a capacitor on input line.
- ■To apply square waveform input voltage, which is commonly used in UPS and Inverter.

6 Assembling and Installation Method

6.1 Installation method

■When two or more power supplies are used side by side, position them with proper intervals to allow enough air ventilation. Ambient temperature around each power supply should not exceed the temperature range shown in derating curve.



- ■When installing the components (inclusive chassis) or pattern which is a foreign potentials around the unit, keep the distance for more than 5mm. If this distance can not be kept, insert the insulation sheet between them.
- ■Avoid placing the AC input line pattern lay out underneath the unit as it will increase the line conducted noise. Make sure to leave an ample distance between the line pattern lay out and the unit. Also, avoid placing the DC output line pattern underneath the unit because it may increase the output noise. Lay out the pattern away from the unit.

6.2 Derating

■When unit mounted except below drawings, it is required to consider ventilated environment by forced air cooling for temperature/load derating. For details, please consult our sales or engineering departments.

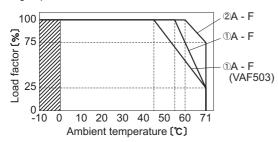


Fig.6.1 VAF5 Derating curve

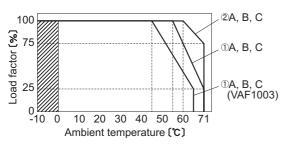


Fig.6.2 VAF10 Derating curve

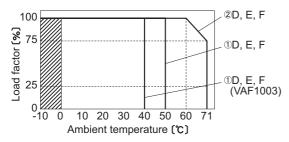


Fig.6.3 VAF10 Derating curve

- 1 Convection
- ② Forced Air(0.5m³/min)

In case 2, ventilation must keep the temperature of C16 below 80°C. Refer to External View for the location of C16.

Note:

In the hatched area, the specification of Ripple, Ripple Noise are different from the other.

Cleaning

■Cleaning agents: IPA (Solvent type)

■Cleaning period: When cleaning the unit, the unit must be washed

with a brush, and IPA must be kept out of the

unit.

■After cleaning, dry them enough.

8 Soldering

■Dip soldering : 260°C less than 10 seconds. ■Soldering iron: 350°C less than 3 seconds.

9 Input/Output Pin

- ■When too much stress is applied on the input/output pins of the unit, the internal connection may be weakened. As below Fig.9.1, avoid applying stress of more than 9.8N (1kgf) on the pins horizontally and more than 19.6N (2kgf) vertically.
- ■The input/output pins are soldered on PCB internally, therefore, do not pull or bend them with abnormal forces.
- ■When additional stress is expected to be put on the input/output pins because of vibration or impacts, fix the unit on PCB (using silicone rubber or fixing fittings) to reduce the stress onto the input/output pins

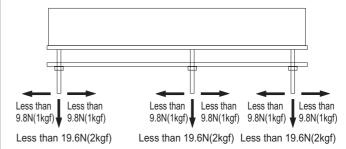


Fig.9.1 Stress on to the pins

Ground

■When installing the power supply with your unit, ensure that the input FG terminal is connected to safety ground of the unit. However, when applying the safety agency, connect the input FG terminal to safety ground of the unit.



11 Others

- ■This power supply is rugged PCB. Do not drop conductive object in the power supply.
- ■At light load, there remains high voltage inside the power supply for a few minutes after power OFF. So at maintenance, take care about electric shock.
- ■This power supply is manufactured by SMD technology. The stress to PCB like twisting or bending causes the defect of the unit, so handle the unit with care.

VAF